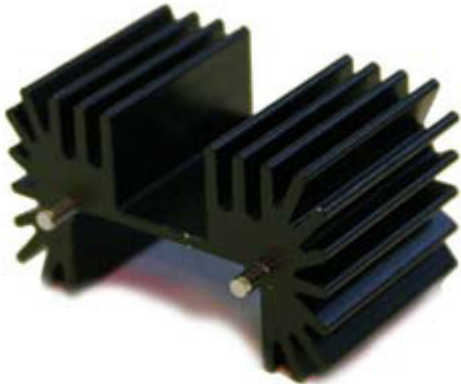


Heatsink Extruded

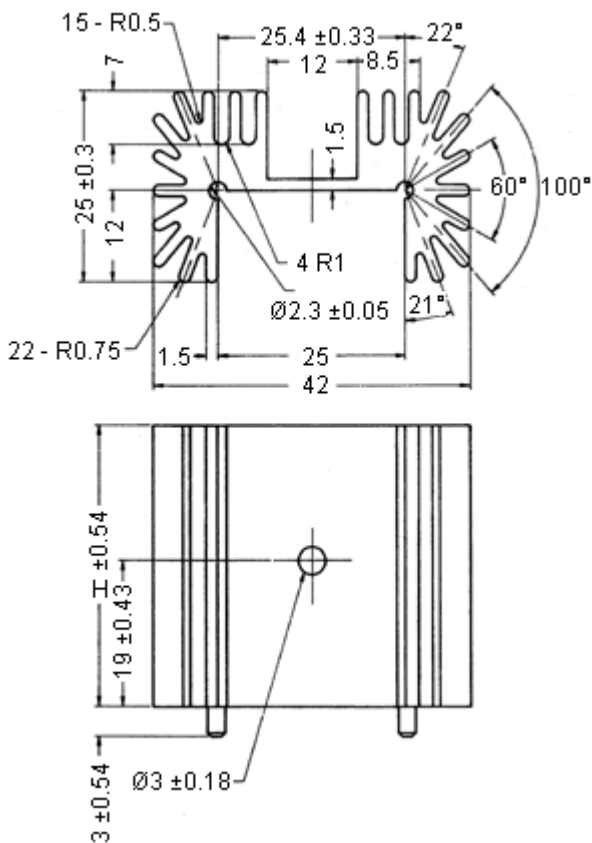


Description:

High power dissipation, vertical mounting extruded heatsink with solderable fixing pins and notched base. Pre-drilled for a single TO218 / 220 / 247 package

Features:

- Choice of thermal resistance
- Low thermal resistance
- Solderable mounting pins
- Pre-drilled mounting holes
- Black anodize finish



Dimensions : Millimetres

Specification Table

Thermal Resistance	Height (mm)	Device Mtg	Part Number
5.6°C / W	25.4	Mounting Hole	MC33268

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